

	℃，per diode			
				℃

FIG.1: Forward voltage drop vs forward current

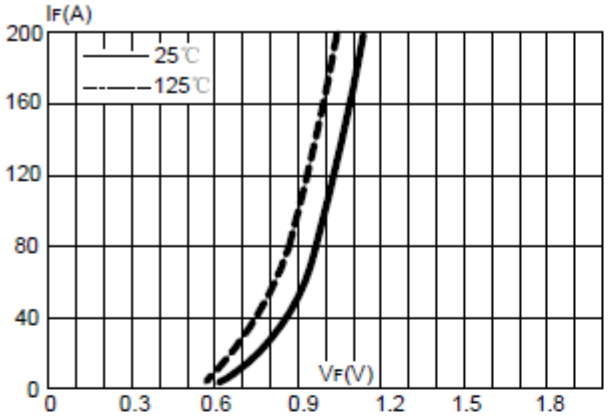


FIG.2: Reverse recovery time vs dI_F/dt

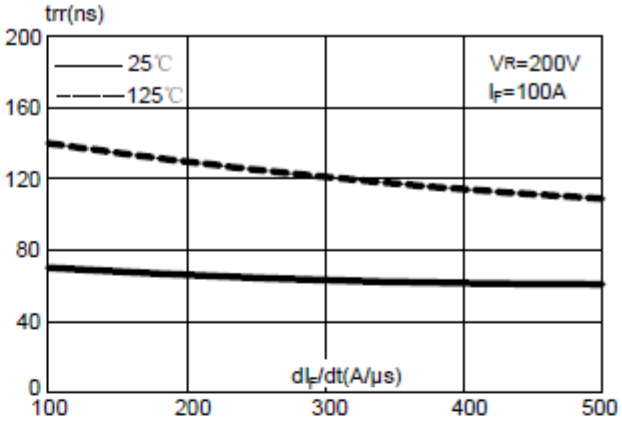


FIG.3: Reverse recovery current vs dI_F/dt

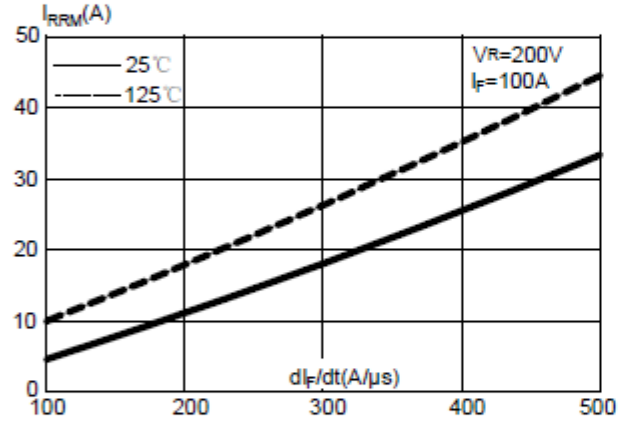


FIG.4: Forward current vs case temperature

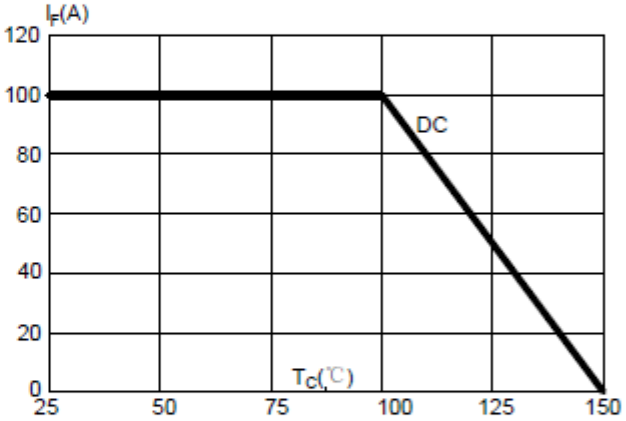
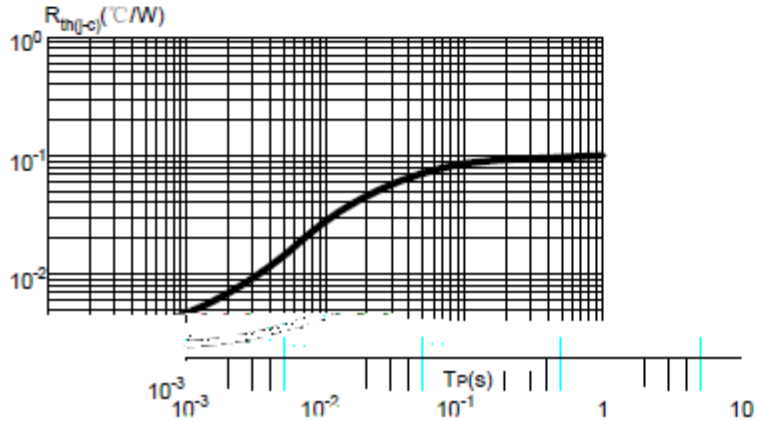
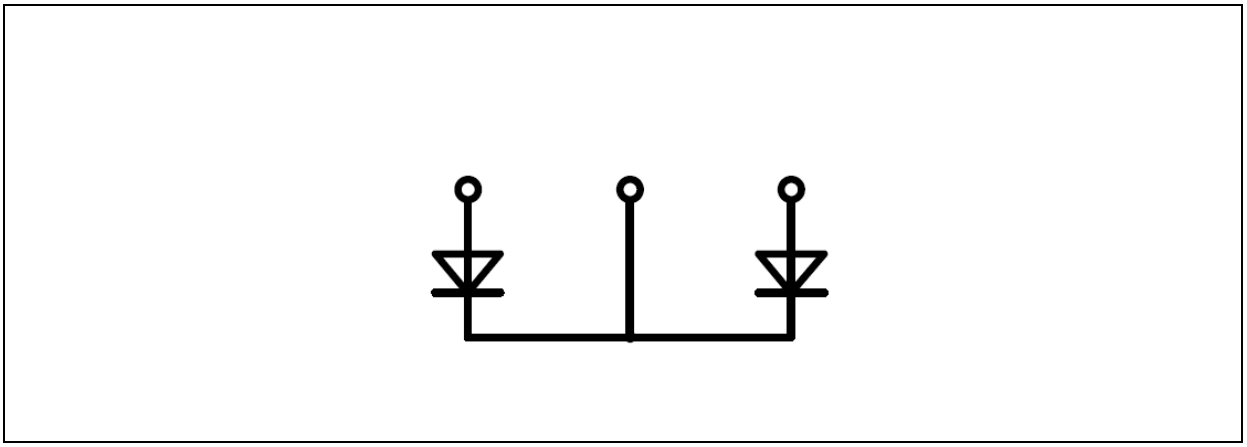
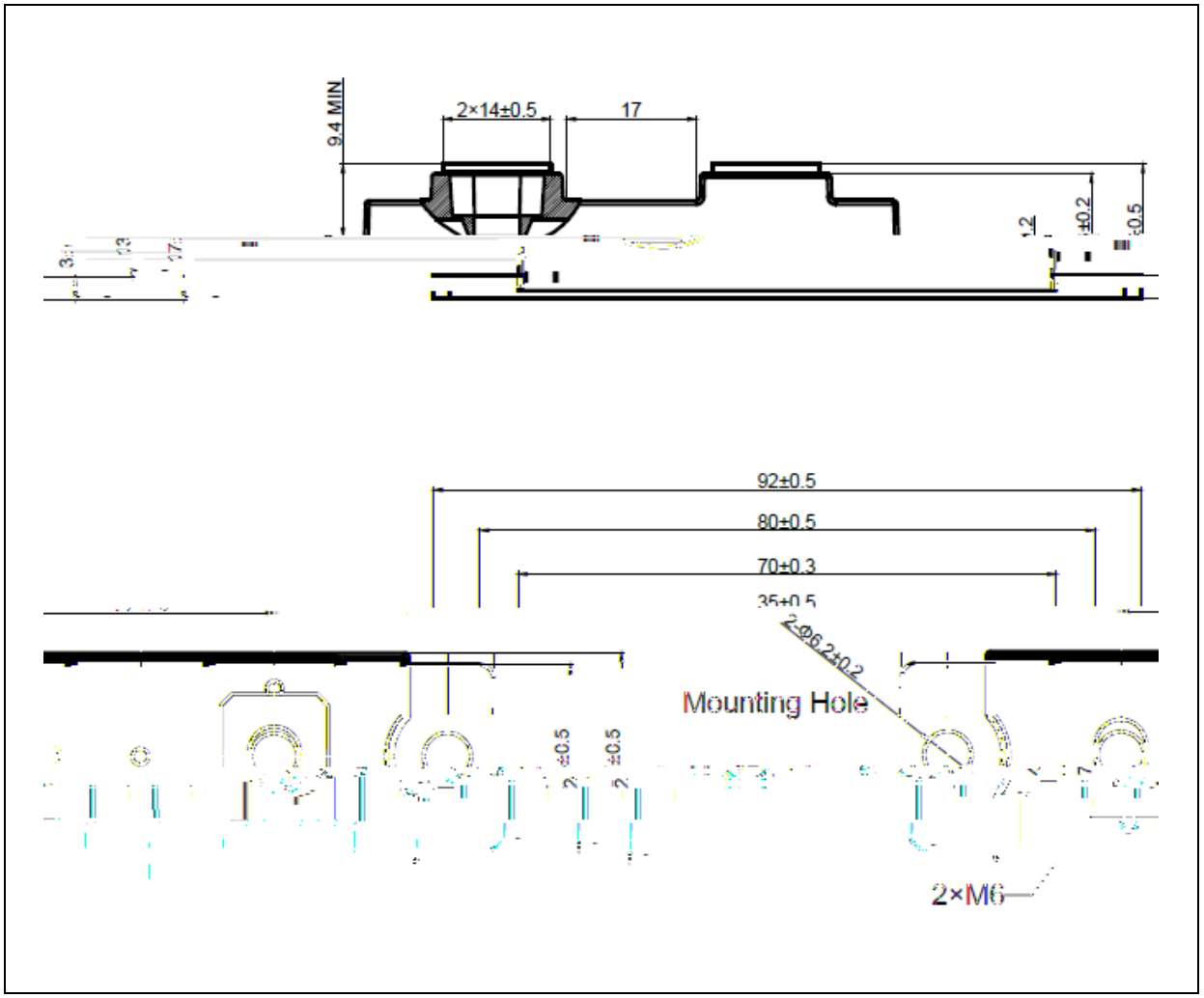


FIG.5: Maximum transient thermal impedance
Junction-to-case(per diode)






9.4 MIN
2×14±0.5
17
12
±0.2
±0.5
92±0.5
80±0.5
70±0.3
35±0.5
2-φ6.2±0.2
Mounting Hole
±0.5
±0.5
2×M6